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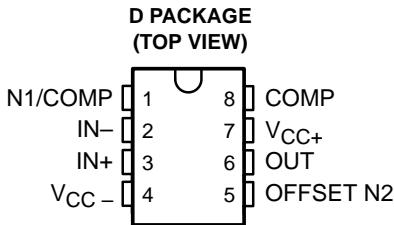
[Texas Instruments](#)

[TL070IDR](#)

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- **Low Power Consumption**
- **Wide Common-Mode and Differential Voltage Ranges**
- **Low Input-Bias and Offset Currents**
- **Output Short-Circuit Protection**
- **Low Total Harmonic Distortion . . . 0.003% Typ**
- **Low Noise . . . $V_n = 18 \text{ nV}/\sqrt{\text{Hz}}$ Typ at $f = 1 \text{ kHz}$**
- **High Input Impedance . . . JFET Input Stage**
- **Common-Mode Input Voltage Range Includes V_{CC+}**
- **Latch-Up-Free Operation**
- **High Slew Rate . . . 13 $\text{V}/\mu\text{s}$ Typ**



description

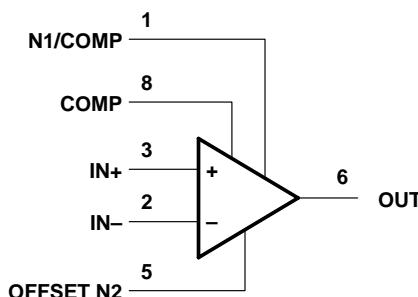
The JFET-input TL070 operational amplifier is designed as the lower-noise version of the TL080 amplifier with low input-bias and offset currents and fast slew rate. The low harmonic distortion and low noise make the TL070 ideally suited for high-fidelity and audio-preamplifier applications. This amplifier features JFET inputs (for high input impedance) coupled with bipolar output stages integrated on a single monolithic chip.

The TL070 device is characterized for operation from -40°C to 85°C .

AVAILABLE OPTIONS

TA	$V_{IO\text{max}}$ AT 25°C	PACKAGE
		SMALL OUTLINE (D)
-40°C to 85°C	10 mV	TL070ID

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

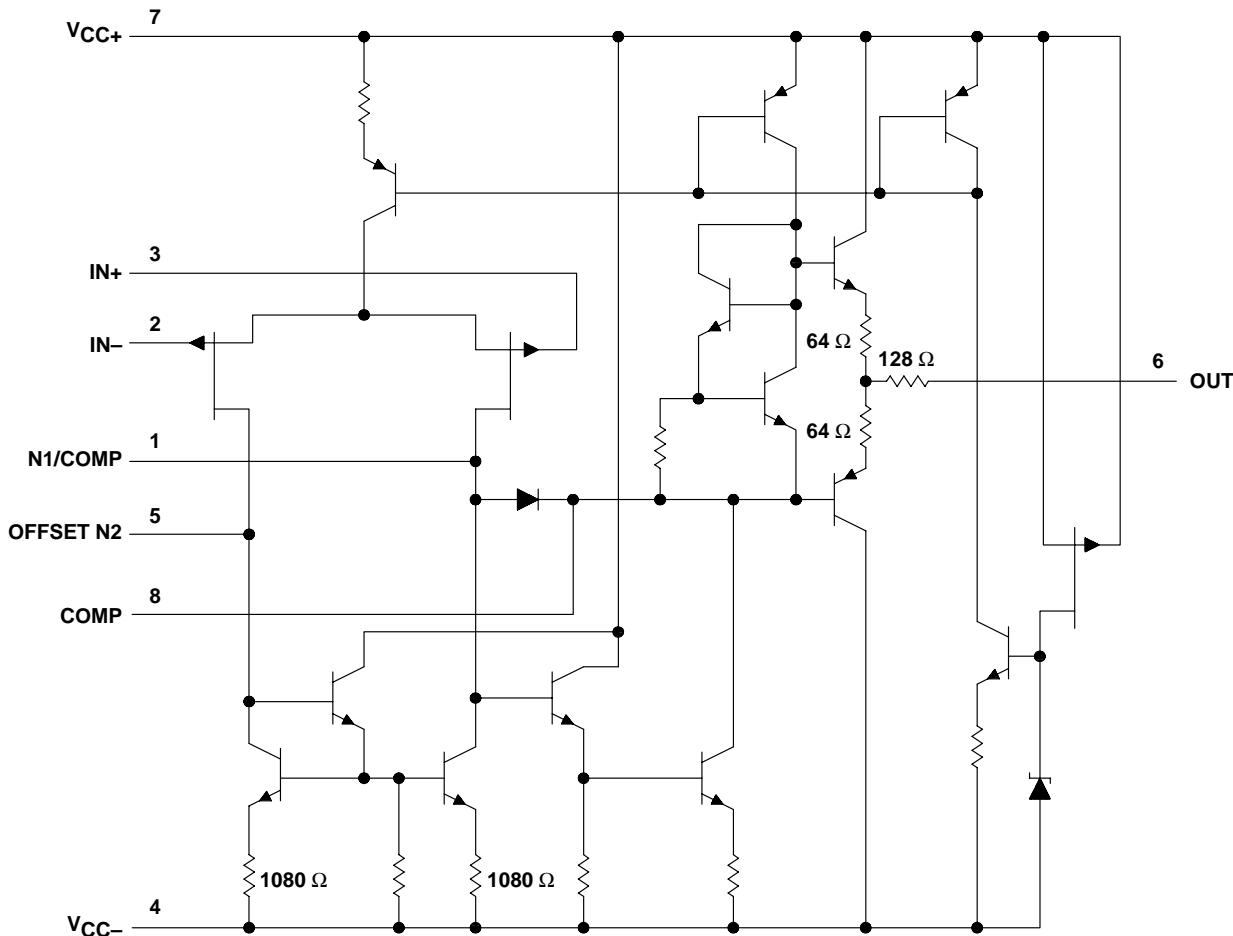


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TL070
JFET-INPUT OPERATIONAL AMPLIFIER

SLOS121B – NOVEMBER 1993 – REVISED MARCH 2001

schematic



All component values shown are nominal.

COMPONENT COUNT†	
Transistors	13
Diodes	2
Resistors	10
epi-FET	1
JFET	2

† Includes all bias and trim circuitry

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential voltages, are with respect to the midpoint between V_{CC+} and V_{CC-} .
 2. Differential voltages are at $IN+$ with respect to $IN-$.
 3. The magnitude of the input voltage must never exceed the magnitude of the supply voltage or 15 V, whichever is less.
 4. The output may be shorted to ground or to either supply. Temperature and/or supply voltages must be limited to ensure that the dissipation rating is not exceeded.
 5. The package thermal impedance is calculated in accordance with JESD 51-7.

TL070

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electrical characteristics, $V_{CC\pm} = \pm 15$ V (unless otherwise noted)

PARAMETER		TEST CONDITIONS	T_A^\dagger	MIN	TYP	MAX	UNIT
V_{IO}	Input offset voltage	$V_O = 0, R_S = 50 \Omega$	25°C	3		10	mV
			Full range	13			
$\alpha_{V_{IO}}$	Temperature coefficient of input offset voltage	$V_O = 0, R_S = 50 \Omega$	Full range	18			$\mu V/^\circ C$
I_{IO}	Input offset current	$V_O = 0$	25°C	5		100	pA
			Full range	10			nA
I_{IB}	Input bias current [‡]	$V_O = 0$	25°C	65		200	pA
			Full range	20			nA
V_{ICR}	Common-mode input voltage range		25°C	± 11		-12 to 15	V
V_{OM}	Maximum peak output voltage swing	$R_L = 10 \text{ k}\Omega$	25°C	± 12		± 13.5	V
		$R_L \geq 10 \text{ k}\Omega$	Full range	± 12			
		$R_L \geq 2 \text{ k}\Omega$		± 10			
A_{VD}	Large-signal differential voltage amplification	$V_O = \pm 10 \text{ V}, R_L \geq 2 \text{ k}\Omega$	25°C	25		200	V/mV
			Full range	15			
B_1	Unity-gain bandwidth		25°C	3			MHz
r_i	Input resistance		25°C	10^{12}			W
CMRR	Common-mode rejection ratio	$V_{IC} = V_{ICR\min}, V_O = 0, R_S = 50 \Omega$	25°C	70		100	dB
k_{SVR}	Supply-voltage rejection ratio ($\Delta V_{CC\pm}/\Delta V_{IO}$)	$V_{CC} = \pm 9 \text{ V to } \pm 15 \text{ V}, V_O = 0, R_S = 50 \Omega$	25°C	70		100	dB
I_{CC}	Supply current	$V_O = 0, \text{ No load}$	25°C	1.4		2.5	mA
V_{O1}/V_{O2}	Crosstalk attenuation	$A_{VD} = 100$	25°C	120			dB

[†] All characteristics are measured under open-loop conditions with zero common-mode voltage unless otherwise specified. Full range for T_A is $-40^\circ C$ to $85^\circ C$.

[‡] Input bias currents of a FET-input operational amplifier are normal junction reverse currents, which are temperature sensitive as shown in Figure 5. Pulse techniques must be used that will maintain the junction temperature as close to the ambient temperature as possible.

operating characteristics, $V_{CC\pm} = \pm 15$ V, $T_A = 25^\circ C$

PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	UNIT
SR	Slew rate at unity gain	$V_I = 10 \text{ V}, R_L = 2 \text{ k}\Omega, C_L = 100 \text{ pF}$, See Figure 1	8	13		$\text{V}/\mu\text{s}$
t_r	Rise-time overshoot factor	$V_I = 20 \text{ mV}, R_L = 2 \text{ k}\Omega, C_L = 100 \text{ pF}$, See Figure 1	0.1			μs
			20			%
V_n	Equivalent input noise voltage	$R_S = 20 \Omega$	$f = 1 \text{ kHz}$	18		$\text{nV}/\sqrt{\text{Hz}}$
			$f = 10 \text{ Hz to } 10 \text{ kHz}$	4		μV
I_n	Equivalent input noise current	$R_S = 20 \Omega, f = 1 \text{ kHz}$		0.01		$\text{pA}/\sqrt{\text{Hz}}$
THD	Total harmonic distortion	$V_O(\text{rms}) = 10 \text{ V}, R_S \leq 1 \text{ k}\Omega, R_L \geq 2 \text{ k}\Omega, f = 1 \text{ kHz}$		0.003		%

APPLICATION INFORMATION

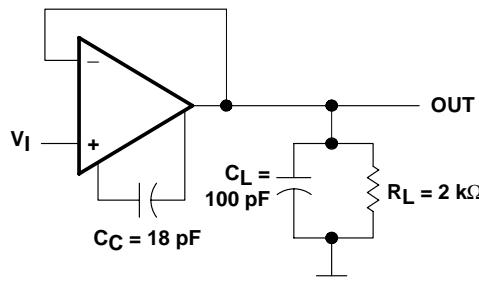


Figure 1. Unity-Gain Amplifier

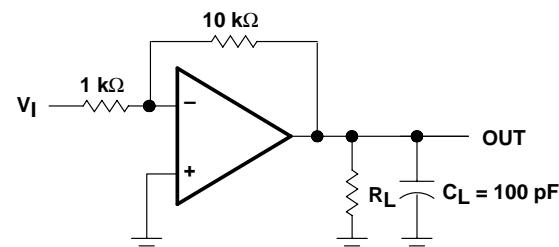


Figure 2. Gain-of-10 Inverting Amplifier

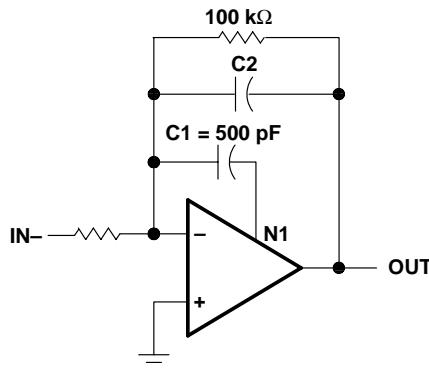


Figure 3. Feed-Forward Compensation

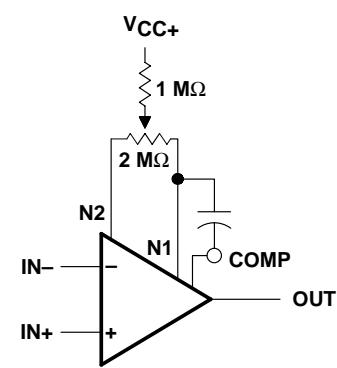


Figure 4. Input Offset Voltage Null Circuit

TL070**JFET-INPUT OPERATIONAL AMPLIFIER**

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TYPICAL CHARACTERISTICS**Table of Graphs**

	FIGURE
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Maximum peak output voltage vs Supply voltage	11
Large-signal differential voltage amplification vs Free-air temperature	12
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Supply current vs Free-air temperature	18
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Equivalent input noise voltage vs Frequency	21
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TYPICAL CHARACTERISTICS[†]

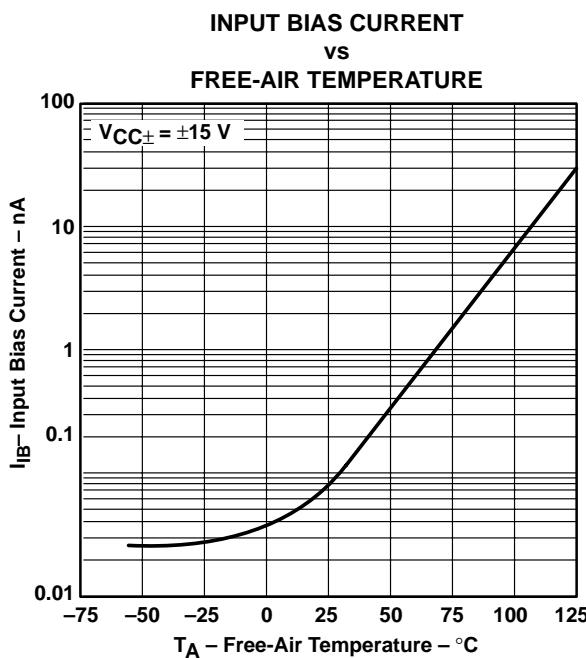


Figure 5

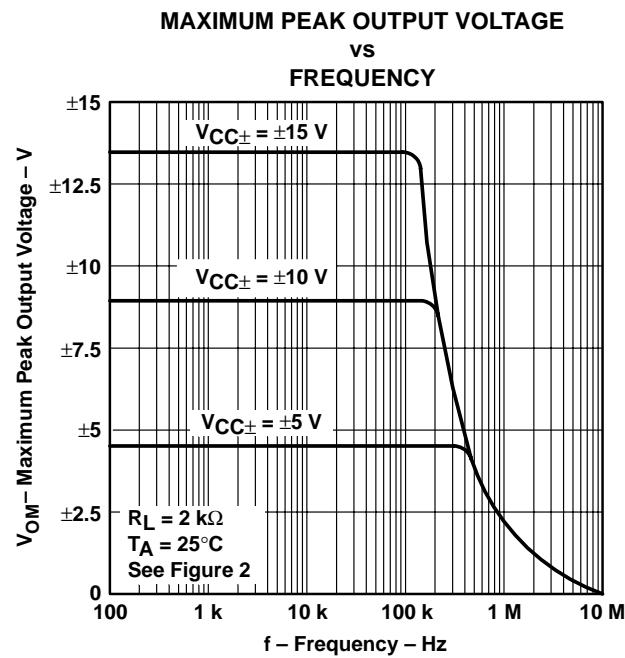


Figure 6

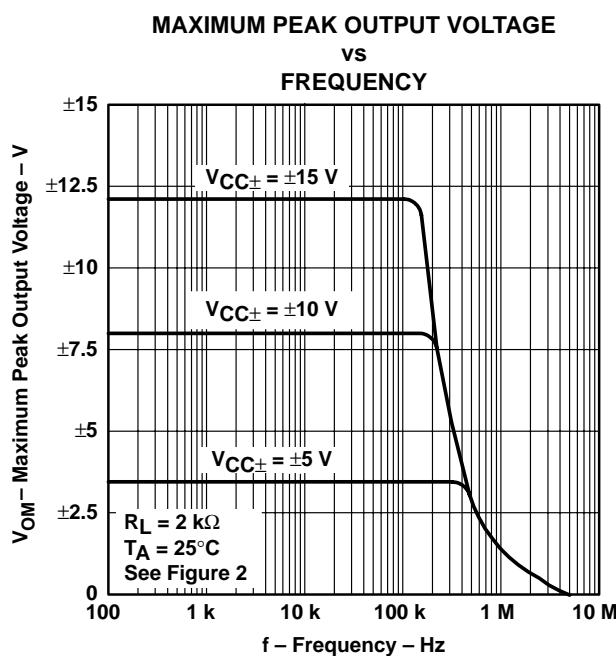


Figure 7

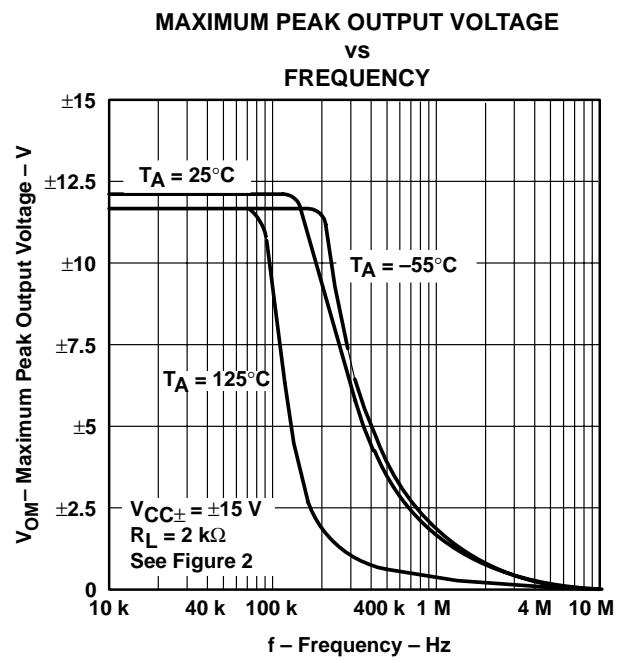


Figure 8

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices. An 18-pF compensation capacitor is used.

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TYPICAL CHARACTERISTICS[†]

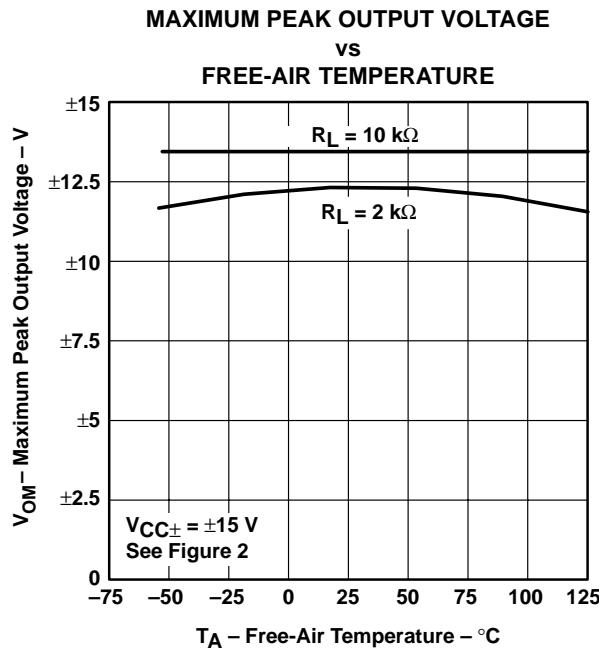


Figure 9

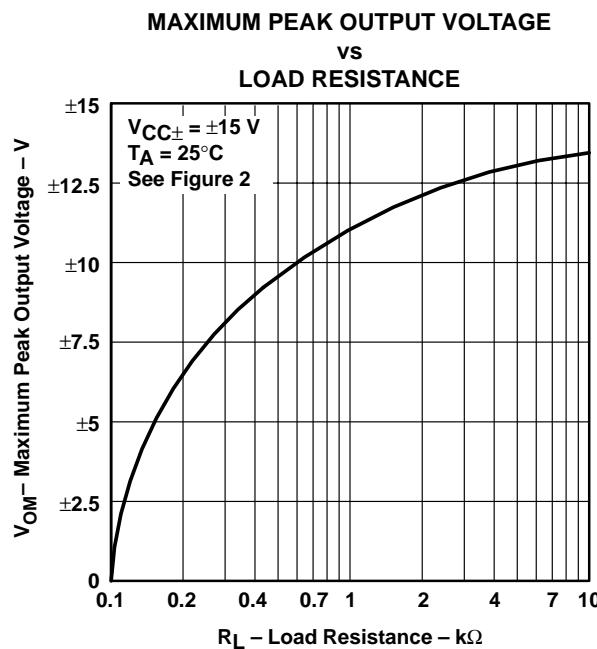


Figure 10

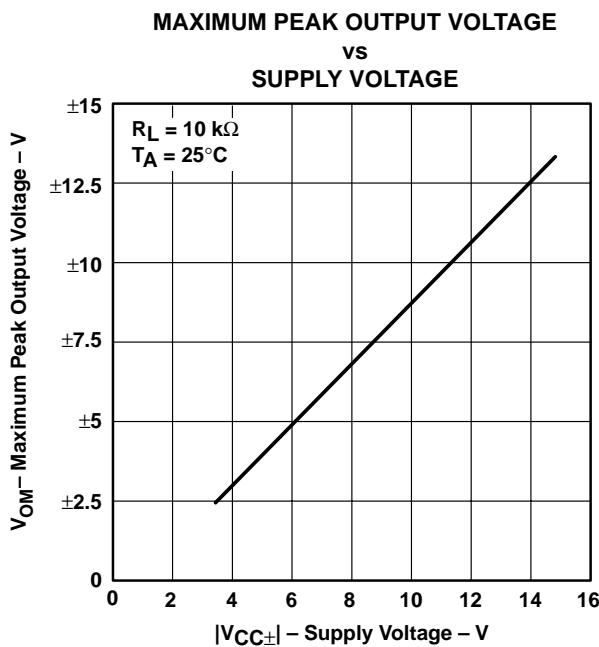


Figure 11

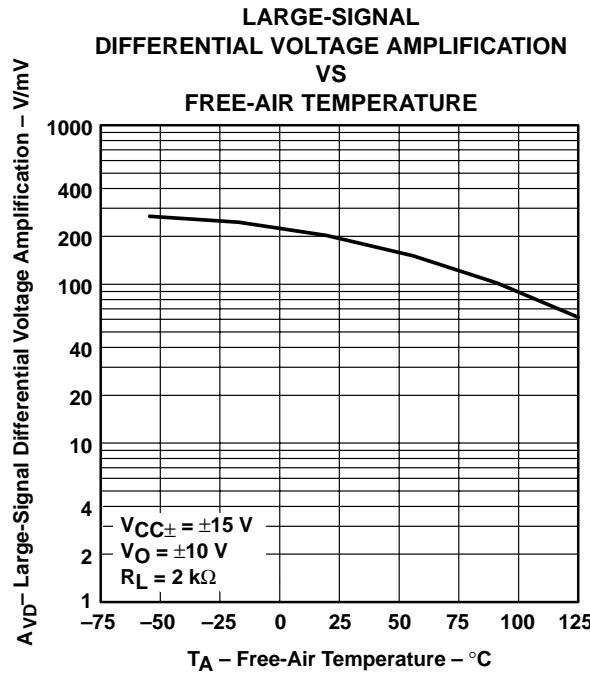


Figure 12

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices. An 18-pF compensation capacitor is used.

TYPICAL CHARACTERISTICS[†]

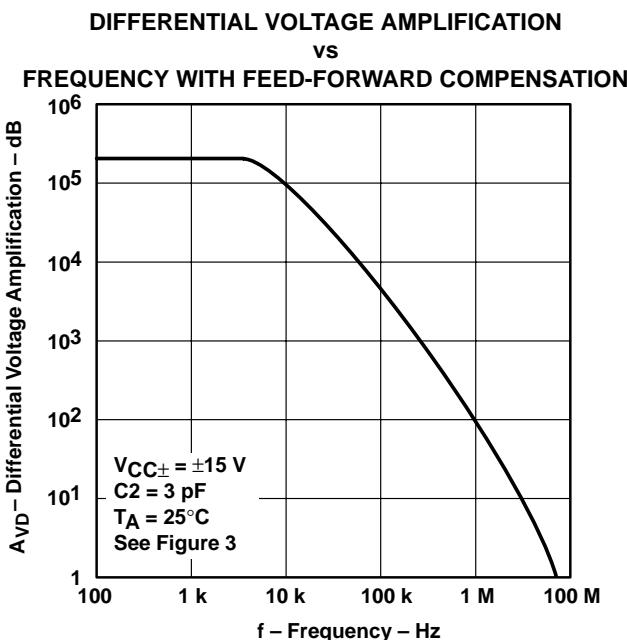


Figure 13

**LARGE-SIGNAL
DIFFERENTIAL VOLTAGE AMPLIFICATION
AND PHASE SHIFT
vs
FREQUENCY**

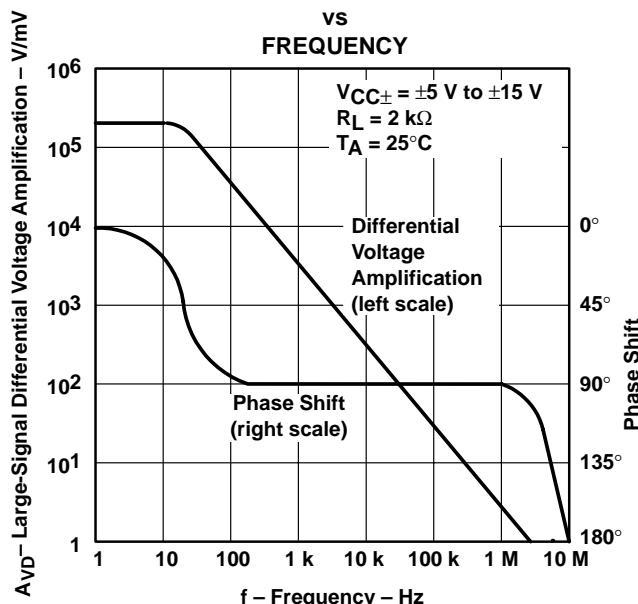


Figure 14

**NORMALIZED UNITY-GAIN BANDWIDTH
AND PHASE SHIFT
vs
FREE-AIR TEMPERATURE**

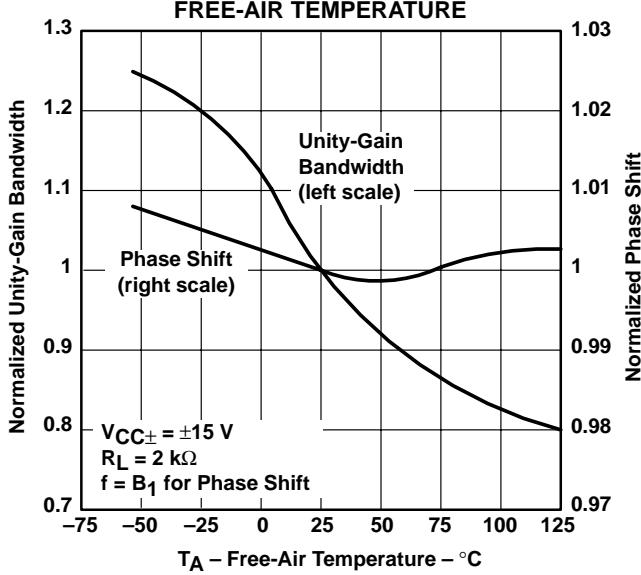


Figure 15

**COMMON-MODE REJECTION RATIO
vs
FREE-AIR TEMPERATURE**

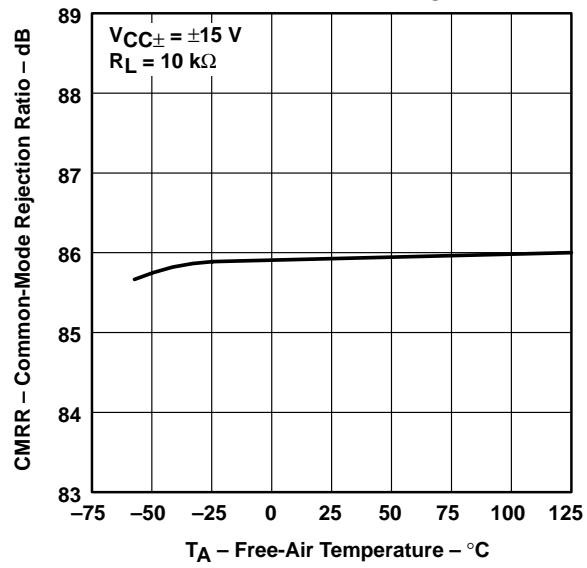


Figure 16

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices. An 18-pF compensation capacitor is used.

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TYPICAL CHARACTERISTICS[†]

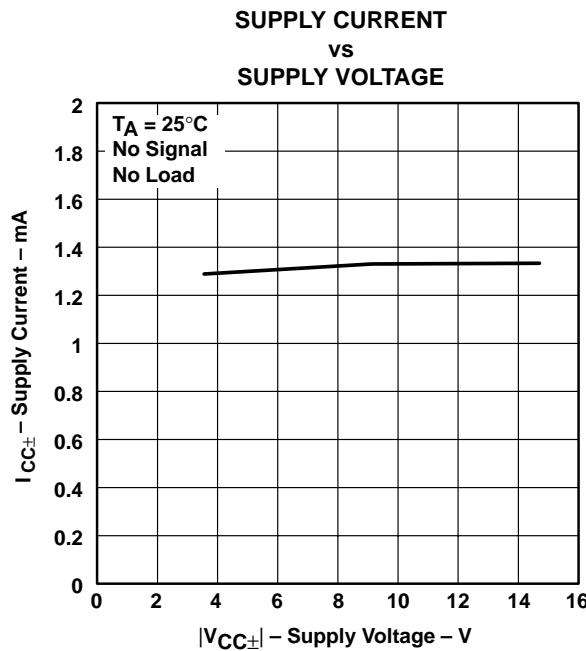


Figure 17

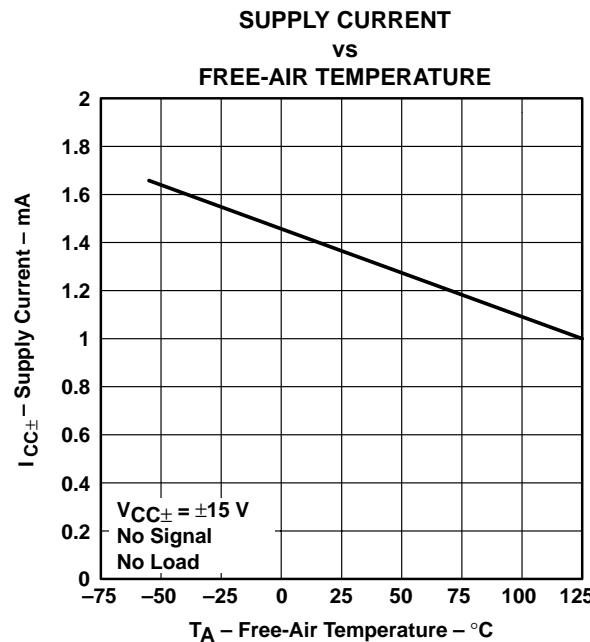


Figure 18

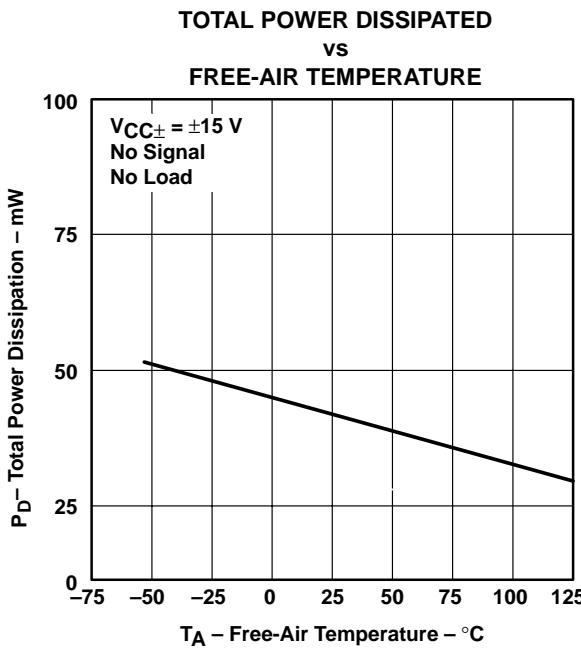


Figure 19

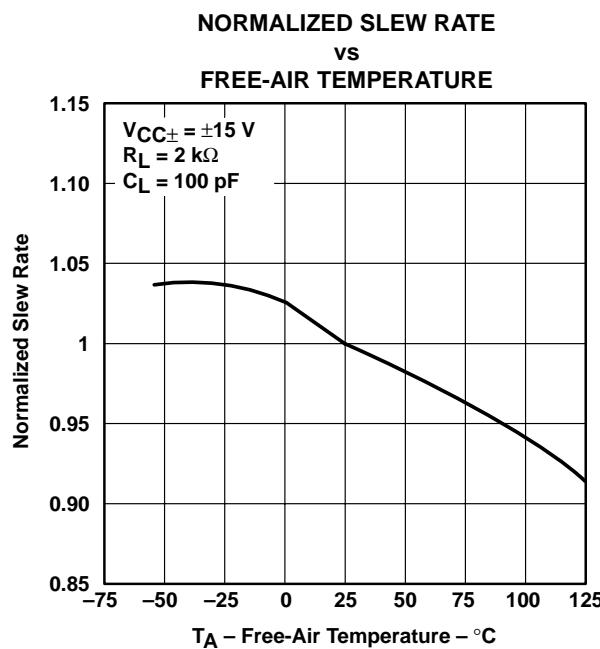


Figure 20

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices. An 18-pF compensation capacitor is used.

TYPICAL CHARACTERISTICS

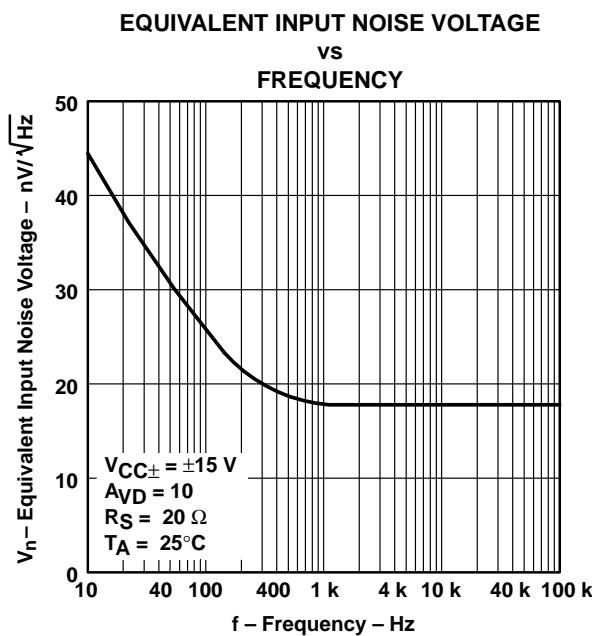


Figure 21

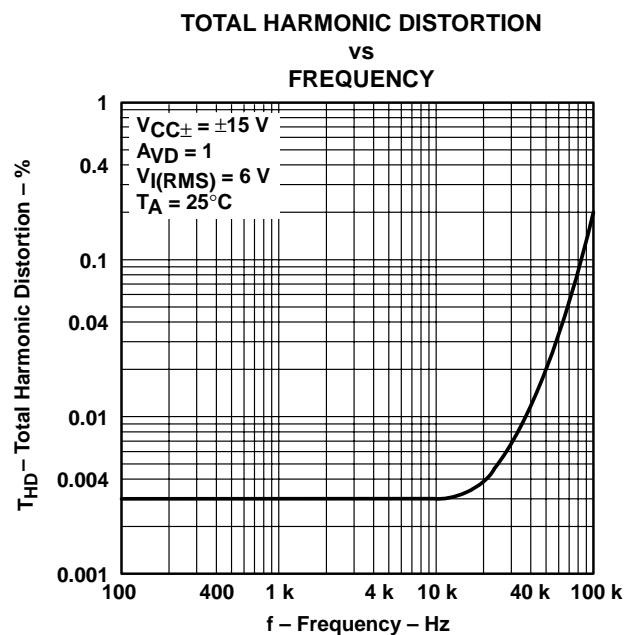


Figure 22

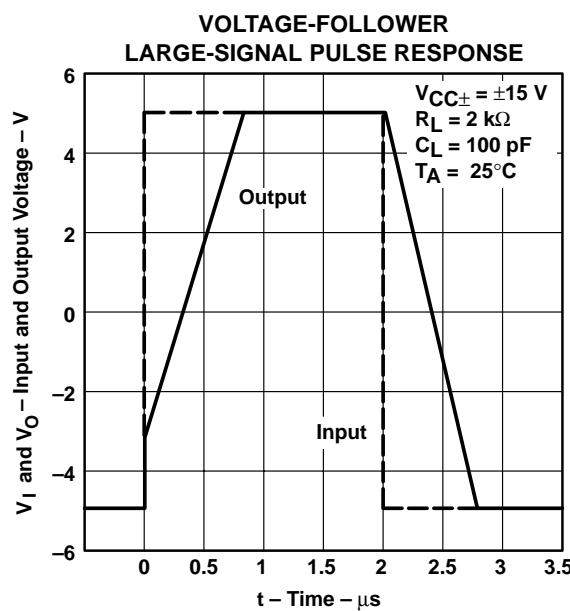


Figure 23

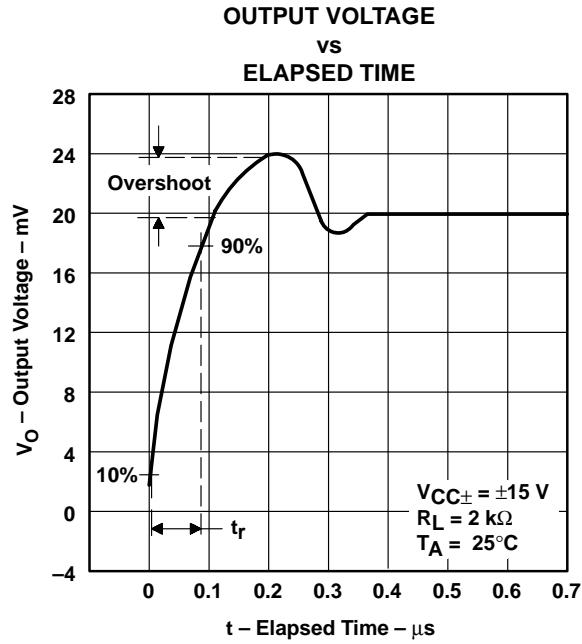


Figure 24

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APPLICATION INFORMATION

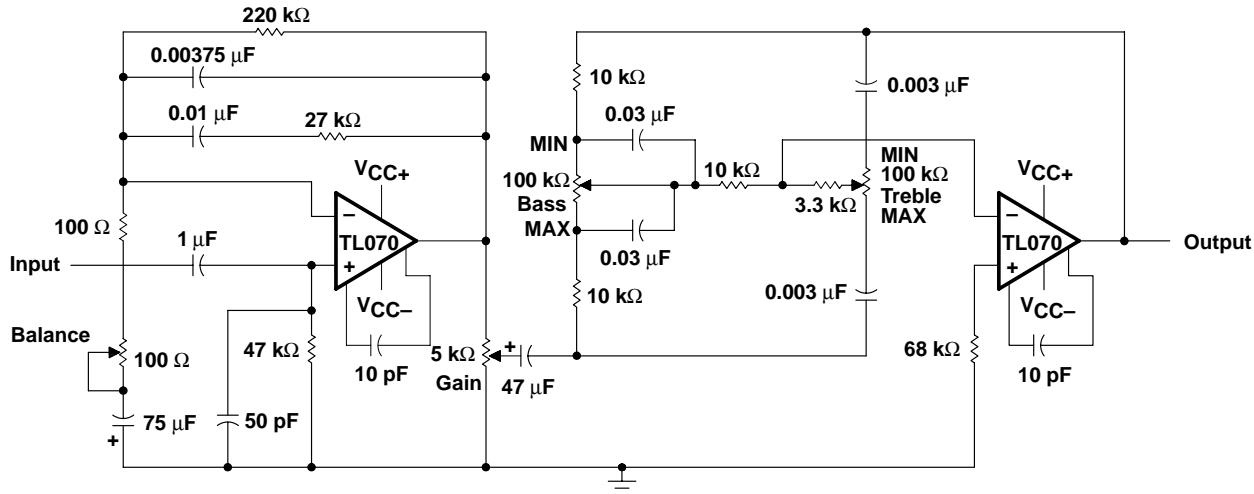


Figure 25. IC Preamplifier

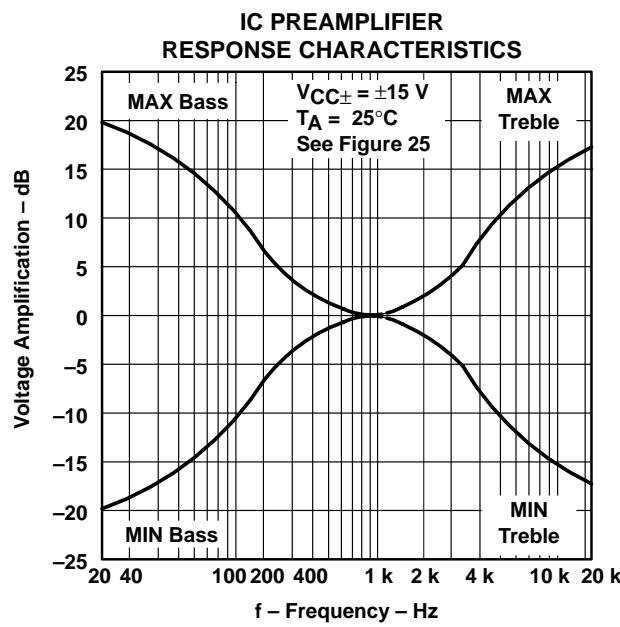


Figure 26

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
TL070CD	OBsolete	SOIC	D	8		TBD	Call TI	Call TI	Samples Not Available
TL070CP	OBsolete	PDIP	P	8		TBD	Call TI	Call TI	Samples Not Available
TL070IP	OBsolete	PDIP	P	8		TBD	Call TI	Call TI	Samples Not Available

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBsolete: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

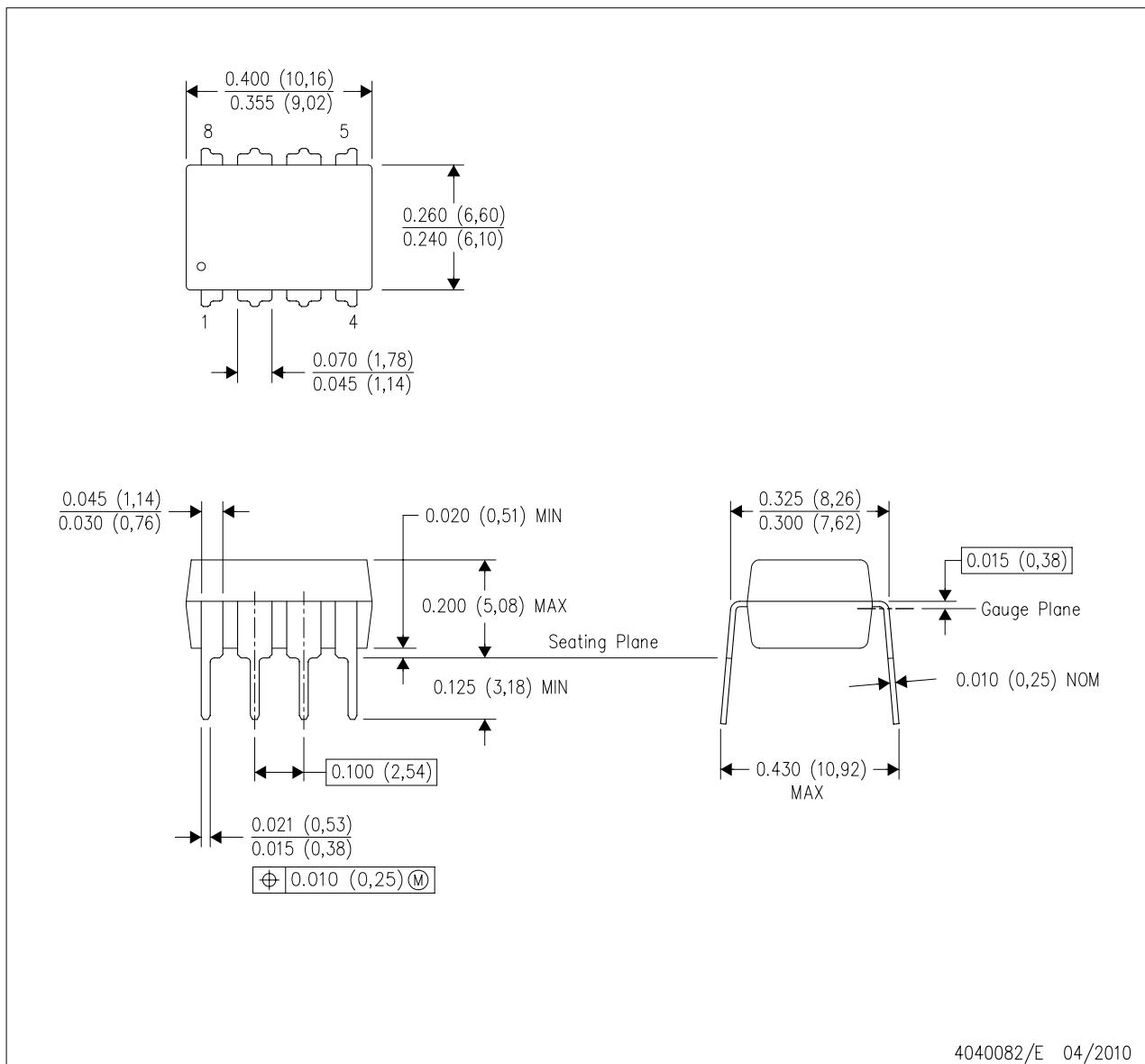
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MECHANICAL DATA

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



4040082/E 04/2010

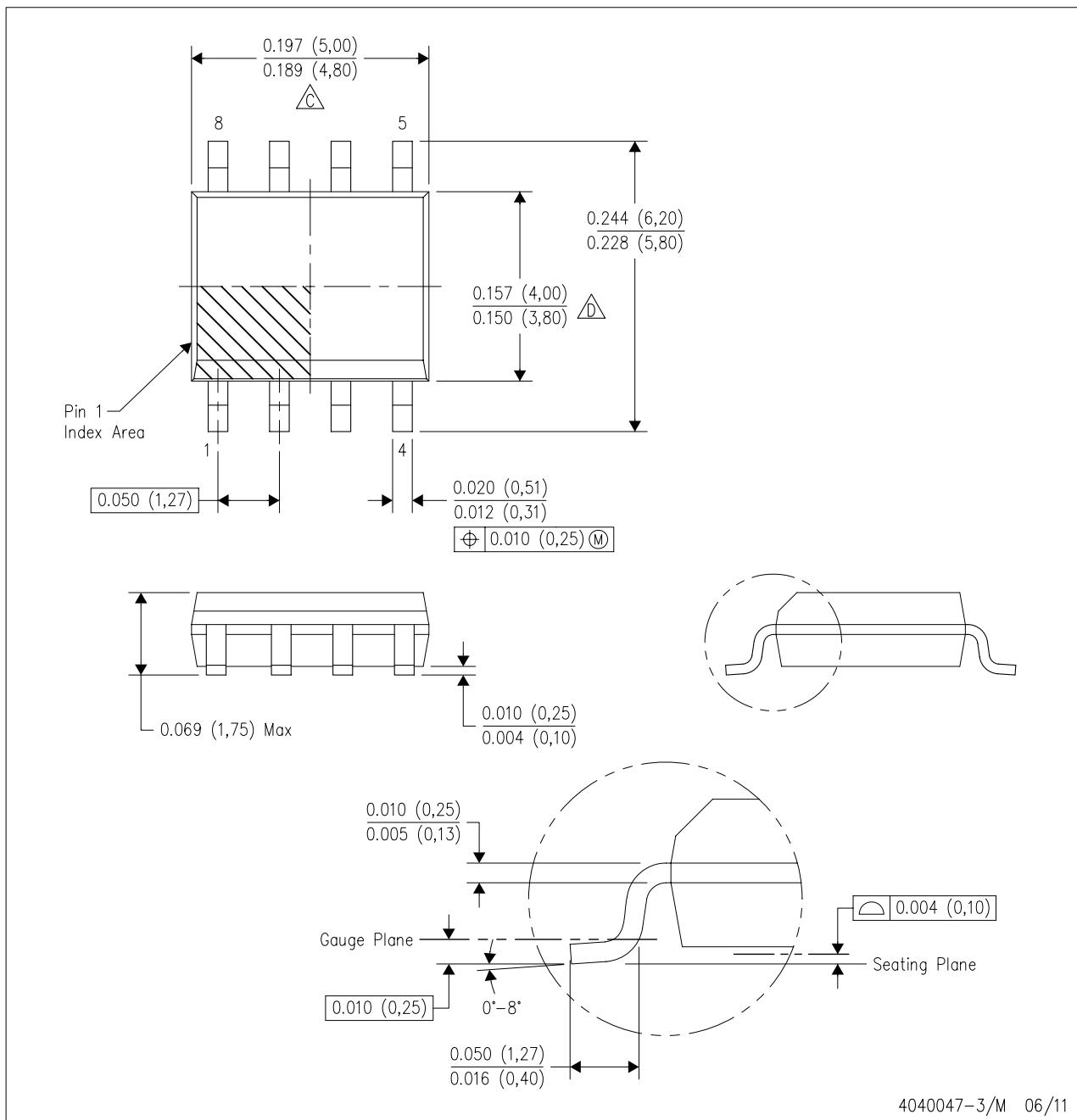
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001 variation BA.

MECHANICAL DATA

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



NOTES:

- All linear dimensions are in inches (millimeters).
- This drawing is subject to change without notice.

Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.

Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.

E. Reference JEDEC MS-012 variation AA.

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